

MOSFET

OptiMOS[™] 5 Power-Transistor, 100 V

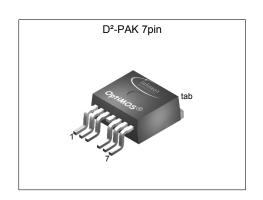
Features

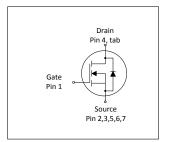
- Ideal for high frequency switching and sync. rec.
 Excellent gate charge x R_{DS(on)} product (FOM)
 Very low on-resistance R_{DS(on)}
 N-channel, normal level

- 100% avalanche tested
- Pb-free plating; RoHS compliant
 Qualified according to JEDEC¹⁾ for target applications
 Halogen-free according to IEC61249-2-21



Parameter	Value	Unit
$V_{ t DS}$	100	V
R _{DS(on),max}	2.4	mΩ
I _D	221	Α
Q _{oss}	142	nC
Q _G (0V10V)	111	nC











Type / Ordering Code	Package	Marking	Related Links
IPB024N10N5	PG-TO263-7	024N10N5	-

OptiMOS[™] 5 Power-Transistor, 100 V



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OptiMOS[™] 5 Power-Transistor, 100 V . IPB024N10N5



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 **Maximum ratings**

Danamatan	O h l		Value	S			
Parameter	Symbol	Min.	Min. Typ. Max.		Unit	Note / Test Condition	
Continuous drain current ¹⁾	I _D	-	-	221 169	А	T _C =25 °C T _C =100 °C	
Pulsed drain current ²⁾	I _{D,pulse}	-	-	884	Α	T _C =25 °C	
Avalanche energy, single pulse	E AS	-	-	502	mJ	$I_{\rm D}$ =100 A, $R_{\rm GS}$ =25 Ω	
Gate source voltage	V _{GS}	-20	-	20	V	-	
Power dissipation	P _{tot}	-	-	250	W	T _C =25 °C	
Operating and storage temperature	T _j , T _{stg}	-55	-	175	°C	IEC climatic category; DIN IEC 68-1: 55/175/56	

2 Thermal characteristics

Table 3 Thermal characteristics

Downwoodow	Cymah al	Values			l lmit	Note / Took Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Thermal resistance, junction - case	R _{thJC}	-	0.4	0.6	K/W	-	
Thermal resistance, junction - ambient, minimal footprint	R _{thJA}	-	-	62	K/W	-	
Thermal resistance, junction - ambient, 6 cm ² cooling area ³⁾	R _{thJA}	-	-	40	K/W	-	
Soldering temperature and reflow soldering is allowed	T _{sold}	-	-	260	°C	reflow MSL1	

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.

2) see Diagram 3

³⁾ Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

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3 Electrical characteristics

at T_j=25 °C, unless otherwise specified

Table 4 Static characteristics

D	0		Values			N	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Drain-source breakdown voltage	V _{(BR)DSS}	100	-	-	V	V _{GS} =0 V, I _D =1 mA	
Gate threshold voltage	V _{GS(th)}	2.2	3.0	3.8	V	V _{DS} =V _{GS} , I _D =183 μA	
Zero gate voltage drain current	I _{DSS}	-	0.1 10	5 100	μΑ	V _{DS} =100 V, V _{GS} =0 V, T _j =25 °C V _{DS} =100 V, V _{GS} =0 V, T _j =125 °C	
Gate-source leakage current	I _{GSS}	-	1	100	nA	V _{GS} =20 V, V _{DS} =0 V	
Drain-source on-state resistance	R _{DS(on)}	-	2.0 2.4	2.4 3.2	mΩ	V _{GS} =10 V, I _D =90 A V _{GS} =6 V, I _D =45 A	
Gate resistance ¹⁾	R _G	-	1.2	1.8	Ω	-	
Transconductance	g fs	105	210	-	S	$ V_{DS} > 2 I_D R_{DS(on)max}, I_D = 90 A$	

Table 5 Dynamic characteristics¹⁾

Develope	Cumbal	Values			11	Nata / Tank Oam distant	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Input capacitance	Ciss	-	7870	10200	pF	V _{GS} =0 V, V _{DS} =50 V, f=1 MHz	
Output capacitance	Coss	-	1200	1560	pF	V _{GS} =0 V, V _{DS} =50 V, f=1 MHz	
Reverse transfer capacitance	Crss	-	53	93	pF	V _{GS} =0 V, V _{DS} =50 V, f=1 MHz	
Turn-on delay time	t _{d(on)}	-	20	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =90 A, $R_{\rm G,ext}$ =1.6 Ω	
Rise time	t _r	-	12	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =90 A, $R_{\rm G,ext}$ =1.6 Ω	
Turn-off delay time	$t_{ m d(off)}$	-	42	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =90 A, $R_{\rm G,ext}$ =1.6 Ω	
Fall time	t _f	-	13	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =90 A, $R_{\rm G,ext}$ =1.6 Ω	

Table 6 Gate charge characteristics²⁾

Dovomotor	Cumbal	Values			l lmi4	Note / Test Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Gate to source charge	Q _{gs}	-	36	-	nC	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =90 A, $V_{\rm GS}$ =0 to 10 V	
Gate to drain charge ¹⁾	$Q_{ m gd}$	-	23	34	nC	V_{DD} =50 V, I_{D} =90 A, V_{GS} =0 to 10 V	
Switching charge	Q _{sw}	-	35	-	nC	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =90 A, $V_{\rm GS}$ =0 to 10 V	
Gate charge total ¹⁾	Q g	-	111	138	nC	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =90 A, $V_{\rm GS}$ =0 to 10 V	
Gate plateau voltage	V _{plateau}	-	4.6	-	V	V _{DD} =50 V, I _D =90 A, V _{GS} =0 to 10 V	
Output charge ¹⁾	Qoss	-	142	188	nC	V _{DD} =50 V, V _{GS} =0 V	

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

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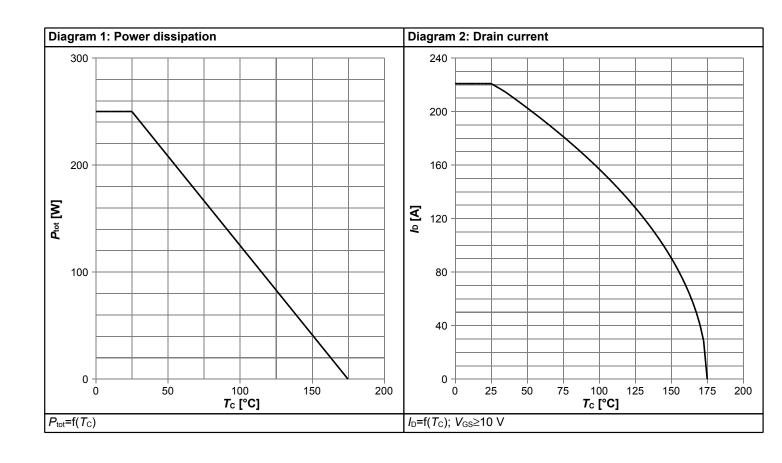


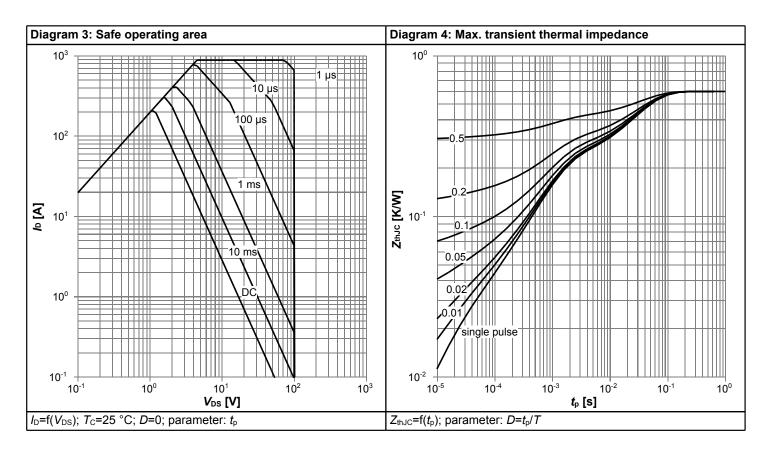
Table 7 Reverse diode

Develope	Comple ed		Values			Nata / Tank Oan Hitian	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Diode continous forward current	I _S	-	-	180	Α	<i>T</i> _C =25 °C	
Diode pulse current	I _{S,pulse}	-	-	884	Α	<i>T</i> _C =25 °C	
Diode forward voltage	V _{SD}	-	0.9	1.2	V	V _{GS} =0 V, I _F =90 A, T _j =25 °C	
Reverse recovery time ¹⁾	t _{rr}	-	65	130	ns	V _R =50 V, I _F =90, di _F /dt=100 A/μs	
Reverse recovery charge ¹⁾	Qrr	-	123	246	nC	V _R =50 V, I _F =90, di _F /dt=100 A/μs	

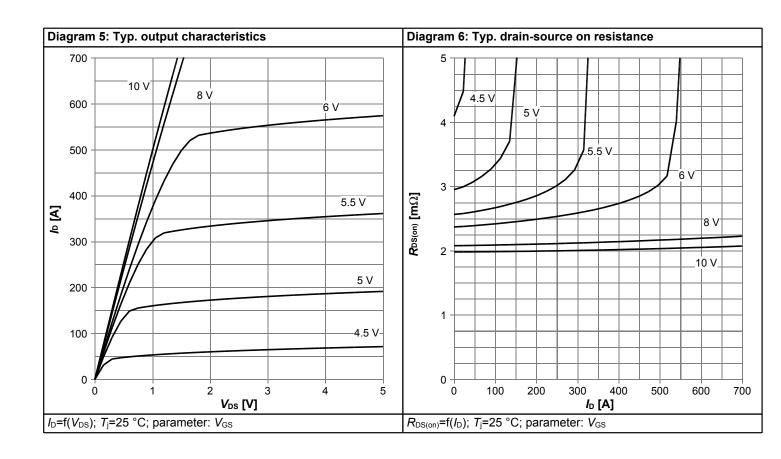


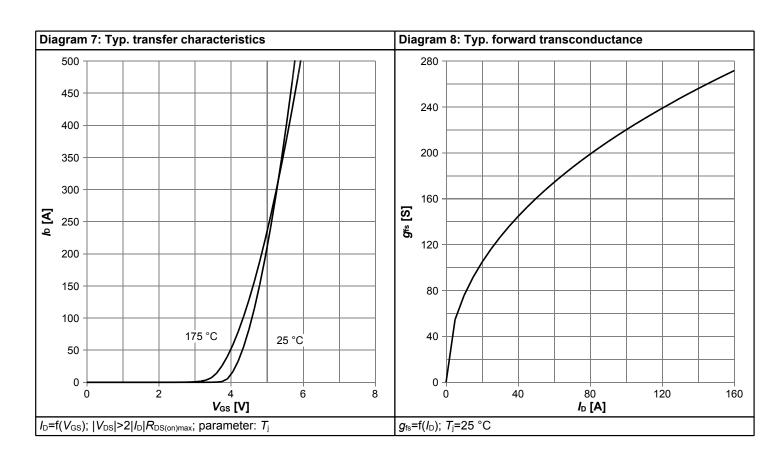
4 Electrical characteristics diagrams



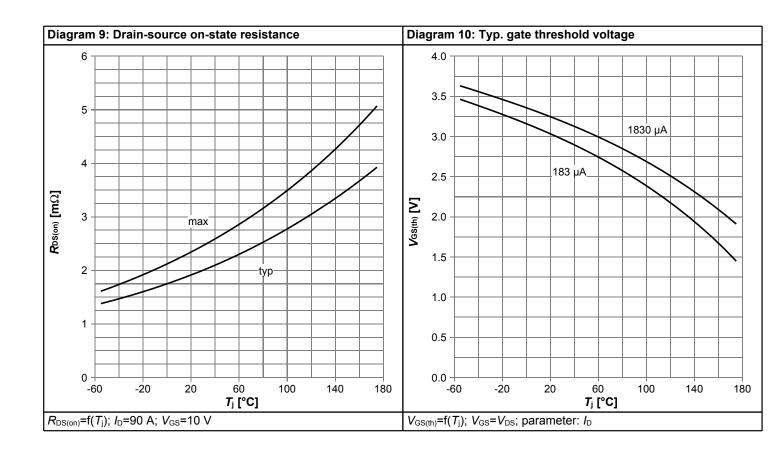


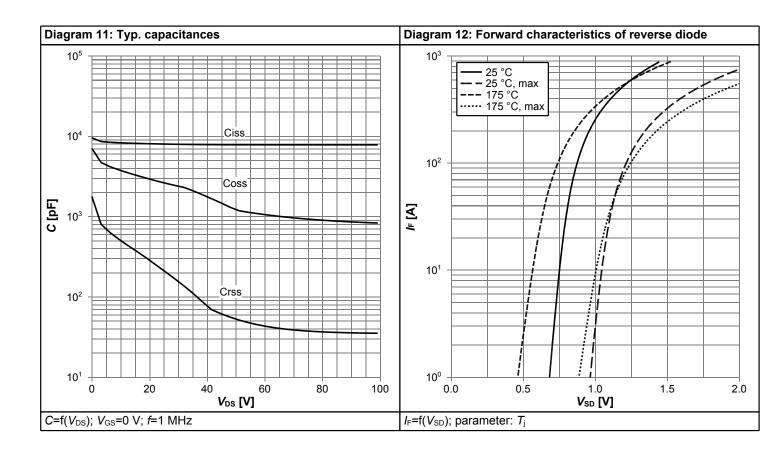




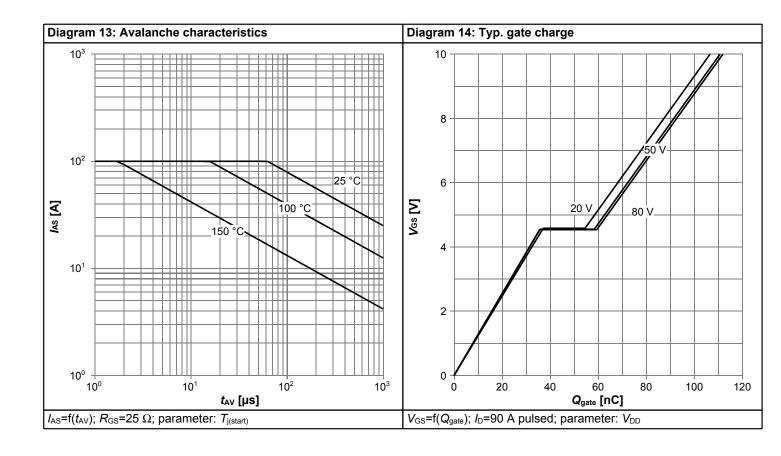


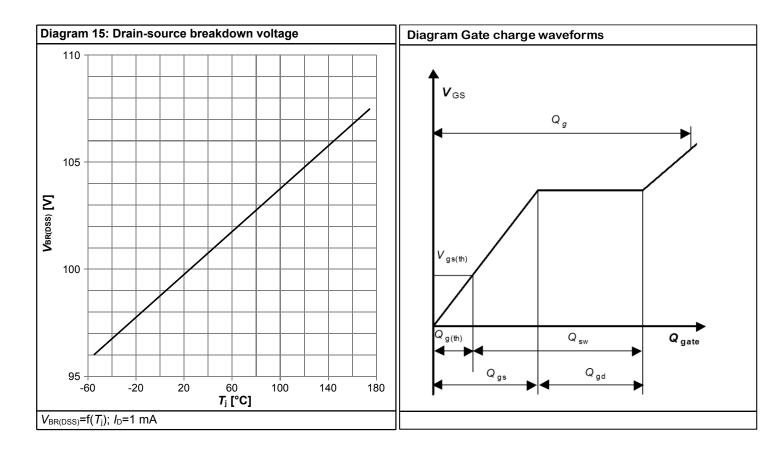






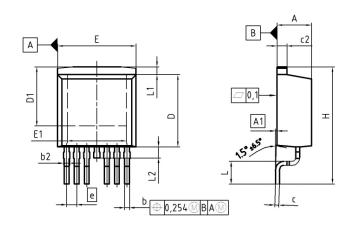


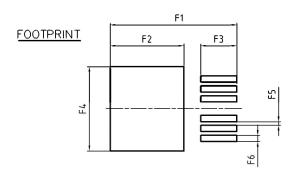






5 Package Outlines





DIM	MILLIM	IETERS	INC	INCHES		
DIM	MIN	MAX	MIN	MAX		
Α	4.30	4.57	0.169	0.180		
A1	0.00	0.25	0.000	0.010		
ь	0.50	0.70	0.020	0.028		
b2	0.50	1.00	0.020	0.039		
С	0.33	0.65	0.013	0.026		
c2	1.17	1.40	0.046	0.055		
D	8.51	9.45	0.335	0.372		
D1	6.90	7.90	0.272	0.311		
E	9.80	10.31	0.386	0.406		
E1	6.50	8.60	0.256	0.339		
е	1.	27	0.0	50		
N		6		6		
Н	14.61	15.88	0.575	0.625		
L	2.29	3.00	0.090	0.118		
L1	0.70	1.60	0.028	0.063		
L2	1.00	1.78	0.039	0.070		
F1	16.05	16.25	0.632	0.640		
F2	9.30	9.50	0.366	0.374		
F3	4.50	4.70	0.177	0.185		
F4	10.70	10.90	0.421	0.429		
F5	0.37	0.57	0.015	0.022		
F6	0.70	0.90	0.028	0.035		

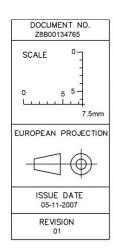


Figure 1 Outline PG-TO263-7, dimensions in mm/inches

OptiMOS[™] 5 Power-Transistor, 100 V IPB024N10N5



Revision History

IPB024N10N5

Revision: 2020-12-22, Rev. 2.2

Previous Revision

Revision	Date	Subjects (major changes since last revision)				
2.0	2016-04-11	Release of final version				
2.1	2016-10-03	Update Avalanche Energy				
2.2	2020-12-22	Update current rating				

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